

CH7511B eDP to LVDS Converter

FEATURES

- Supports Embedded DisplayPort (eDP) Specification version 1.2.
- Support 2 Main Link Lanes at either 1.62Gb/s or 2.7Gb/s link rate for notebook PC applications
- Supports input color depth 6, 8-bit per pixel in RGB format
- Supports Enhanced Framing Mode
- Support VESA and CEA timing standards up to 1920x1200 resolution in 8-bit input with 60Hz refresh rate
- Support dynamic refresh rate switching
- Support Gamma correction
- Panel tuning methods including dithering and 6-bit + FRC
- Fast and full Link Training for embedded DisplayPort system
- Support eDP Authentication: Alternative Scramble Seed Reset and Alternative Framing
- 2 work modes: connect 27MHz crystal, inject 27MHz clock
- Programmable LCD panel power sequence
- Support 18-bit Single Port, 18-bit Dual Port, 24-bit
 Single Port and 24-bit Dual Port LVDS output interface
- Support both OpenLDI and SPWG bit mapping for LVDS application
- Support panel select by GPIO pins control or writing the chip registers.
- Flexible LVDS output pins swapping
- Blank panel during invalid input/
- Supports PWM. Backlight luminance level control through AUX channel, PWM pin and BLUP/BLDN pin Support Dynamic Backlight Control
- Support OSD display when BLOP/BLDN pins control Backlight Luminance
- Hot Plug Detection
- Loads Boot ROM automatically upon power up
- Serial BOOT ROM data updated through I2C bus or AUX Channel
- Programmable power management
- EMI reduction capability for eDP input and LVDS output. Spread spectrum control is available for transmitting LVDS signal
- Offered in a 68-pin QFN package

GENERAL DESCRIPTION

Chrontel's CH7511B is a low-cost, low-power semiconductor device that translates the Embedded DisplayPort signal to the LVDS (Low-voltage Differential Signaling). This innovative DisplayPort receiver with an integrated LVDS transmitter is specially designed to target the All-In-One PC and the notebook market segments. Through the CH7511B's advanced decoding / encoding algorithm, the input eDP high-speed serialized video data can be seamlessly converted to LVDS, a popular display technology for high-speed serial links in mid/large-sized LCD displays. Leveraging the eDP's unique source/sink "Link Training" routine, the CH7511B is capable of instantly bring up the video display to the LCD when the initialization process is completed between CH7511B and the graphic chip.

The CH7511B is designed to meet the Embedded DisplayPort Specification version 1.2. In the device's receiver block, which supports two eDP Main Link Lanes input with data rate running at either 1.62Gb/s or 2.7Gb/s, can accept RGB digital formats in either 1.8-bit 6:6:6 or 24-bit 8:8:8 for LVDS output up to 1920x1200. To comply with GPU's new power saving scheme such as display frame rate reduction, the CH7511B is equipped with the Dynamic Refresh Rate switching method, which can automatically reduce to the low refresh rate supported by the LVDS panel.

The integrated LVDS transmitter supports the single port and the dual ports LVDS outputs to drive display resolution up to WUXGA (1920x1200). CH7511B supports panel select by GPIO[0:3] pins control or writing the chip registers. To reduce EMI emission, the CH7511B s LVDS encoder block has incorporated Spread Spectrum control and its spread percentage can be adjusted through the internal registers.

The Backlight On/Off and the PWM are two luminance control functions designed in the CH7511B LVDS power control module. The brightness control commands sent through AUX Channel can be dynamically translated by CH7511B and converted into LCD backlight control signal. The CH7511B will save the last setting of brightness level into the BOOT ROM and restore it upon power up. The CH7511B can dynamically adjust backlight brightness according to video stream to save power consumption and it supports OSD display in this way.

The CH7511B will immediately convert the eDP signal to LVDS output after eDP Link Training is completed. This feature can be achieved by loading the panel's EDID and the CH7511B's configuration settings in the serial BOOT ROM connected to the CH7511B. During system power-up and upon completion of the eDP Link Training through AUX Channel, CH7511B will generate LVDS signal according to the panel power-up timing sequencing stored in the BOOT ROM.

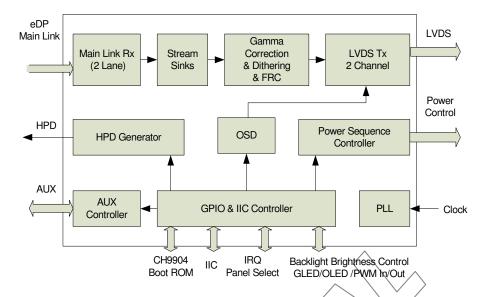


Figure 1: CH7511B Function Block Diagram

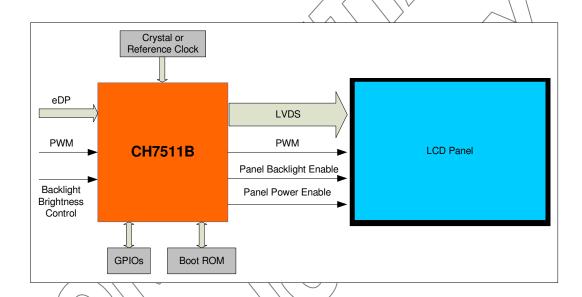
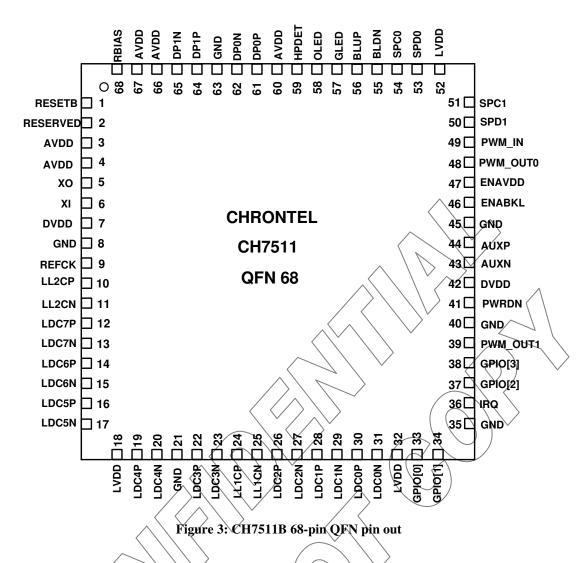


Figure 2: CH7511B Application Diagram

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1.0 PIN ASSIGNMENT

1.1 Package Diagram



1.2 Pin Description

Table 1: Pin Description

Pin#	Type	Symbol	Description
1 (In	RESETB	Reset Input (Internal pull-up)
)	When this pin is low, the device is held in the power-on reset condition.
`	$\setminus \bigcirc$	/ (When this pin is high (1.8V), reset is controlled through the serial port
			register. It should be pulled high to DVDD with a 10 K Ω resistor.
2		RESERVED	Reserved
			This pin should be left open in the application.
5	Out	XO \	Crystal Output
		\ \	A parallel resonant 27MHz crystal (± 20 ppm) should be attached between
		\vee	this pin and XI.
			Note: 50ppm to pin XO
6	In	XI	Crystal Input
			A parallel resonant 27MHz crystal (± 20 ppm) should be attached between
			this pin and XO.

			_				
Pin #	Type	Symbol	Description				
1 111 11	Турс	Symbol	Note: 50ppm to pin XI				
9	In	REFCK	Reference Clock Input				
9	111	KLICK	This pin is also used as clock input pin when injecting 27 MHz (3.3V) clock				
			to CH7511B.				
10~17,	Out	LL1CP/N,	LVDS Output				
19,20,	Out	LL2CP/N	LDC7P/N ~ LDC0P/N can be configured to LVDS differential signals, which				
19,20, 22~31		LDC [7:0] P/N	are used as A7M/P to A0M/P.				
22~31		LDC [7.0] F/N	LL1CP/N and LL2CP/N are used as CLK1 and CLK2 respectively.				
33~34,	In	GPIO [3:0]	Panel Select Control Signals				
37~38		[]	These pins could be pulled high (10 K Ω resistor to +3.3V) or low forming into				
			16 different combinations. Every combination can match with one panel type.				
36	Out	IRQ	Programmable Interrupt output				
			Output an interrupt signal while there's input from BLDN or BLUP.				
39	Out	PWM_OUT1	PWM Output for Backlight Brightness Dimming				
			PWM Duty Cycle Range: 30~100%(16/steps)				
			The output Frequency from PWM_OUT1 can be up to 400KHz. Voltage level				
			is 3.3V.				
41	In	PWRDN	Power Down Control				
			CH7511B enters/exit power down state when receiving active low pulse (0V)				
			from this pin.				
43,44	In/Out	AUXP,	AUX Channel Differential Input/Output				
		AUXN	These two pins are eDP AUX Channel control, which supports a half-duplex,				
			bi-directional AC-coupled differential signal.				
46	Out	ENABKL	LCD Panel Backlight Enable				
			Enable backlight of LCD panel (3.3V)				
47	Out	ENAVDD	LCD Panel VCC Enable				
			Enable LCD panel VDD (3.3V)				
48	Out	PWM_OUT0	PWM Output for Backlight Brightness Dimming / Bypass PWM_IN				
			PWM Duty Cycle Range: 0~100%(16 steps) \				
			The output Frequency from PWM_OUTO can be up to 400KHz. Voltage level				
			is(3.3V. \				
			Bypass PWM input, and while in bypass mode, frequency of PWM_OUT0				
			can be up to 1MHz.				
49	In	PWM_IN	Backlight brightness PWM input				
		$\langle \langle \rangle \rangle$	PWM_IN has two work modes: Bypass mode and Duty Cycle Multiplication				
			with AUX CH mode.				
			In bypass mode, the input frequency to PWM_IN can be up to 1MHz.				
	<		In Duty Cycle Multiplication with AUX CH mode, the input frequency to				
			PWM_IN can be up to 50KHz.				
50	1/10	CDD1	Voltage level is 3.3V.				
50	In/Out	SRD1	Serial Port Data Input/Output for Chip BOOT ROM/EDID This pin figure as the bi-directional data pin of the social port and operates				
	//))	This pin functions as the bi-directional data pin of the serial port and operates with inputs from 0 to 3.3V. Outputs are driven from 0 to 3.3V. This pin				
	/						
51	Out	SPC1	requires an external $4K\Omega - 9 K\Omega$ pull up resistor to 3.3V. Serial Port Clock Output for Chip BOOT ROM/EDID				
21	Jul)	SrC1	This pin functions as the clock output of the serial port and operates with				
		\ \	output from 0 to 3.3V. This pin requires an external $4K\Omega - 9K\Omega$ pull up				
			resistor to 3.3V.				
53	In/Out	SPD0	Serial Port Data Input/Output for Register Map				
	111, Jul		This pin is used to access CH7511B internal registers. It functions as the bi-				
		\ \ /	directional data pin of the serial port and operates with input from 0 to 3.3V.				
			Output is driven from 0 to 3.3V. This pin requires an external $6K\Omega - 8K\Omega$				
			pull up resistor to 3.3V.				
54	In	SPC0	Serial Port Clock Input for Register Map				
			This pin is used to access CH7511B internal registers. It functions as the				
	1		clock input of the serial port and operates with input from 0 to 3.3V. This pin				
		1					

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Pin #	Type	Symbol	Description				
			requires an external $6K\Omega$ - $8K\Omega$ pull up resistor to $3.3V$.				
55	In	BLDN	Decrement Backlight Brightness Input				
56	In	BLUP	Increment Backlight Brightness Input				
57	Out	GLED	Green LED Control				
			This pin indicates CH7511B in normal power and mode status. Its output voltage is 3.3V.				
58	Out	OLED	Orange LED Control This pin indicates CH7511B in abnormal power and mode status. Its output flickers from 0 or 3.3V.				
59	Out	HPDET	Hot Plug Detect This output pin is used as the connection detection by a DisplayPort Source system. It generates interrupt pulse as defined by DisplayPort standard. The output voltage is 3.3V. A 100 k Ω resistor should be connected between this pin and GND. It should be linked to DisplayPort source.				
61,62	In	DP[1:0]P/N	Main Link Lane Input				
64,65			These pins accept two AC-coupled differential pairs signals from the eDP transmitter.				
68	In	RBIAS	Band-gap Bias input A 10 K $\Omega(1\%)$ resistor should be connected between this pin and GND.				
3,4,60,66,6 7	Power	AVDD	Analog Power Supply (1.8V)				
7,42	Power	DVDD	Digital Power Supply (1,8V)				
18,32,52	Power	LVDD	LVDS Driver Power Supply and GPO Power Supply (3,3V)				
8,21,35,40, 45,63, Thermal Exposed Pad	Power	GND	Power Ground				

2.0 PACKAGE DIMENSIONS

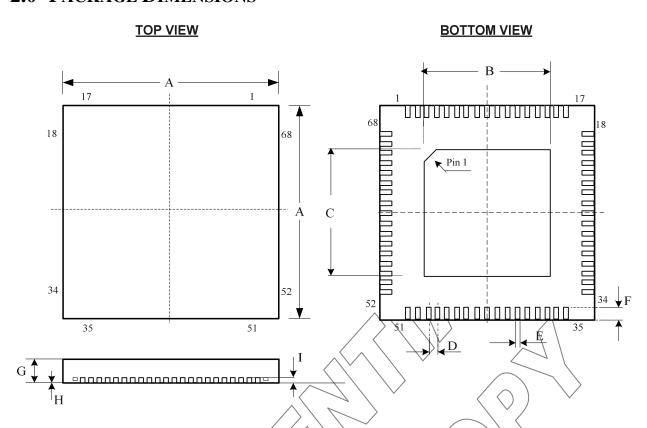


Figure 4: 68 Pin QFN Package (8x8 mm)

Table of Dimensions

No. of Leads		SYMBOL								
68 (8	x8 mm)	A	B \	\rangle c	D	/E <	F	G	Н	Ι
Milli-	MIN	7.90	4.30	4.30	0.40_	0.15	\0.30	0.70	0	0.203
meters	MAX	8,10	4.50	4.50	BSC	0.25	0.50	0.80	0.05	REF

Notes:

1. All dimensions conform to JEDEC standard MO-207

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ORDERING INFORMATION								
Part Number	Package Type	Operating Temperature Range	Minimum Order Quantity					
CH7511B-BF	68QFN, Lead-free	Commercial: 0 to 70°C	260/TRAY					
CH7511B-BFI	68QFN, Lead-free	Industrial: 40 to 85°C	260/TRAY					

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